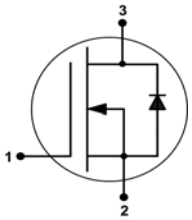
OptiMOS™2 Small-Signal-Transistor

Features

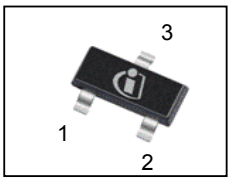
- N-channel
- Enhancement mode
- Logic level (4.5V rated)
- Avalanche rated
- Qualified according to AEC Q101
- 100% lead-free; RoHS compliant
- Halogen-free according to IEC61249-2-21

Product Summary

V_{DS}		30	V
$R_{DS(on),max}$	V_{GS}=10 V	57	mΩ
	V_{GS}=4.5 V	93	
I_D		2.3	A



PG-SOT23



Type	Package	Tape and Reel Information	Marking	Lead Free	Packing
BSS306N	SOT23	H6327: 3000 pcs/ reel	SWs	Yes	Non dry

Maximum ratings, at T_j=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I_D	T_A=25 °C	2.3	A
		T_A=70 °C	1.8	
Pulsed drain current	$I_{D,pulse}$	T_A=25 °C	9	
Avalanche energy, single pulse	E_{AS}	I_D=2.3 A, R_{GS}=25 Ω	10.8	mJ
Reverse diode dv/dt	dv/dt	I_D=2.3 A, V_{DS}=16 V, di/dt=200 A/µs, $T_{j,max}$=150 °C	6	kV/µs
Gate source voltage	V_{GS}		±20	V
Power dissipation	P_{tot}	T_A=25 °C	0.5	W
Operating and storage temperature	T_j, T_{stg}		-55 ... 150	°C
ESD Class		JESD22-A114 -HBM	0 (<250V)	
Soldering Temperature			260 °C	
IEC climatic category; DIN IEC 68-1			55/150/56	

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal characteristics						
Thermal resistance, junction - ambient	R_{thJA}	minimal footprint [1)]	-	-	250	K/W
Electrical characteristics, at T_j=25 °C, unless otherwise specified						
Static characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS}=0 V, I_D=250 µA	30	-	-	V
Gate threshold voltage	$V_{GS(th)}$	V_{DS}=V_{GS} , I_D=11 µA	1.2	1.6	2	
Drain-source leakage current	I_{DSS}	V_{DS}=30 V, V_{GS}=0 V, T_j=25 °C	-	-	1	µA
		V_{DS}=30 V, V_{GS}=0 V, T_j=150 °C	-	-	100	
Gate-source leakage current	I_{GSS}	V_{GS}=20 V, V_{DS}=0 V	-	-	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	V_{GS}=4.5 V, I_D=1.85 A	-	67	93	mΩ
		V_{GS}=10 V, I_D=2.3 A	-	44	57	
Transconductance	g_{fs}	$\|V_{DS}\|>2\|I_D\|R_{DS(on)max}$, I_D=1.8 A	-	5	-	S

[1)] Performed on 40mm^2 FR4 PCB. The traces are 1mm wide, 70µm thick and 20mm long; they are on both sides of the PCB.

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Dynamic characteristics						
Input capacitance	C_{iss}	V_{GS}=0 V, V_{DS}=15 V, f=1 MHz	-	207	275	pF
Output capacitance	C_{oss}		-	75	100	
Reverse transfer capacitance	C_{rss}		-	12	17	
Turn-on delay time	$t_{d(on)}$	V_{DD}=15 V, V_{GS}=10 V, I_D=2.3 A, R_G=6 Ω	-	4.4	-	ns
Rise time	t_r		-	2.3	-	
Turn-off delay time	$t_{d(off)}$		-	8.3	-	
Fall time	t_f		-	1.4	-	
Gate Charge Characteristics						
Gate to source charge	Q_{gs}	V_{DD}=15 V, I_D=2.3 A, V_{GS}=0 to 5 V	-	0.65	-	nC
Gate to drain charge	Q_{gd}		-	0.45	-	
Gate charge total	Q_g		-	1.5	-	
Gate plateau voltage	$V_{plateau}$		-	3.1	-	V
Reverse Diode						
Diode continous forward current	I_S	T_A=25 °C	-	-	0.5	A
Diode pulse current	$I_{S,pulse}$		-	-	9	
Diode forward voltage	V_{SD}	V_{GS}=0 V, I_F=2.3 A, T_j=25 °C	-	0.83	1.1	V
Reverse recovery time	t_{rr}	V_R=10 V, I_F=2.3 A, di_F/dt=100 A/µs	-	14.4	-	ns
Reverse recovery charge	Q_{rr}		-	2.9	-	nC